



Bill of Materials

TI DESIGNS

TIDA-00387

Item	Qty	Reference	Value	Part Description	Manufacturer	Manufacturer Part Number	Alternate Part	PCB Footprint	Note
1	2	C1, C2	1uF	Capacitor, Ceramic, 6.3V, X5R, 20%	TDK	C1608X5R0J105M	C1608X5R0J105K	603	
2	1	C3	Not populated	-	-	-	-	-	Not Populated
3	6	J1, J2, J3, J4, J5, J6	PEC02SAAN	Header, 2-pin, 100mil spacing	Sullins	PEC02SAAN	-	0.100 inch x 2	
4	2	JP1, JP2	PEC03SAAN	Header, 3-pin, 100mil spacing	Sullins	PEC03SAAN	-	0.100 inch x 3	
5	1	U1	TLV7101828DSE	IC, Dual 200mA, LDO Regulator	TI	TLV7101828DSE	-	SON-6	

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